

Product Summary

V _{RRM} (V)	I _O (A)	V _{Fmax} (V)	I _{R max} (μA)
60	3	0.65	100

Description and Applications

The SBR3U60P1 is a single rectifier in POWERDI123 package. Offering excellent high temperature stability and very low forward voltage, this device is ideal for use in the following applications.

- Bridge diodes
- Blocking diodes
- Reverse protection diodes

Features and Benefits

- Ultra Low Forward Voltage Drop
- Low reverse leakage current
- Patented Interlocking Clip Design for High Surge Current Capacity
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: POWERDI123
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ^(e3)
- Weight: 0.018 grams (approximate)

POWERDI123



Top View



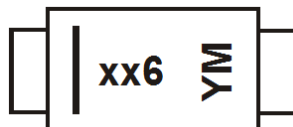
Device symbol

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR3U60P1-7	POWERDI123	3000/Tape & Reel
SBR3U60P1-13	POWERDI123	10,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>

Marking Information



SV6, 3U6 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: Y = 2011)
 M = Month (ex: 9 = September)

Date Code Key

Year	2011	2012	2013	2014	2015	2016	2017
Code	Y	Z	A	B	C	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	60	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
RMS Reverse Voltage	V _{R(RMS)}	42	V
Average Rectified Output Current (See Figure 1)	I _O	3.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	80	A
Repetitive Peak Avalanche Energy (1μs, +25°C)	P _{ARM}	2100	W

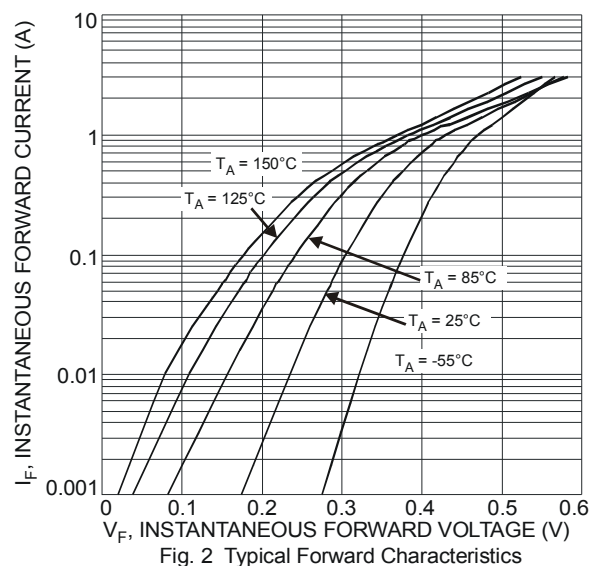
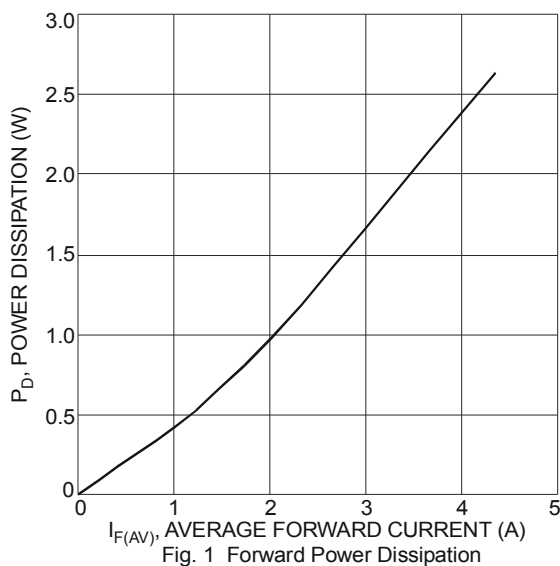
Thermal Characteristics

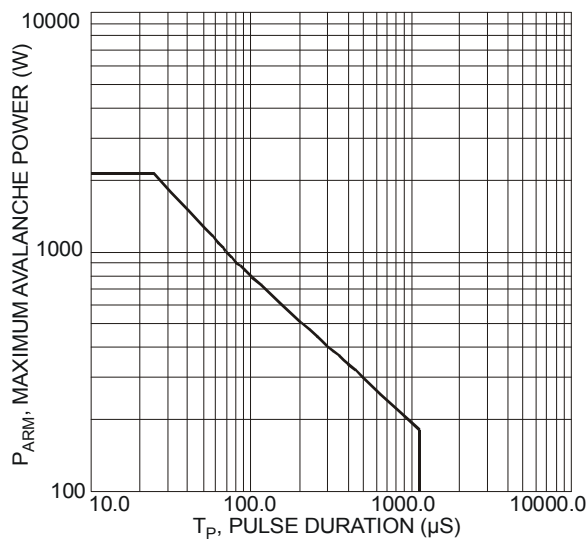
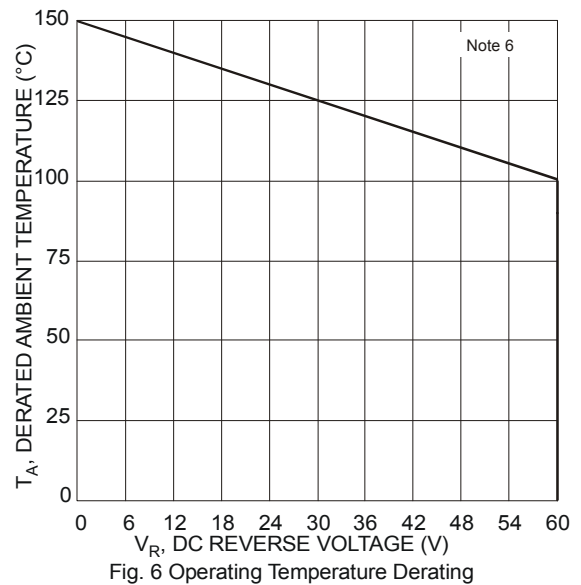
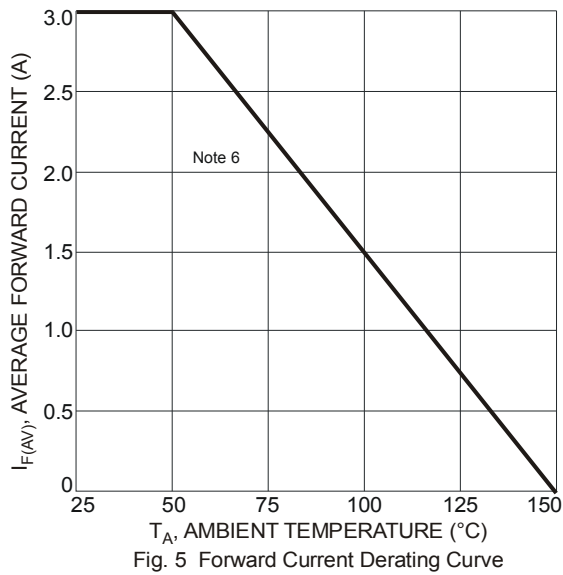
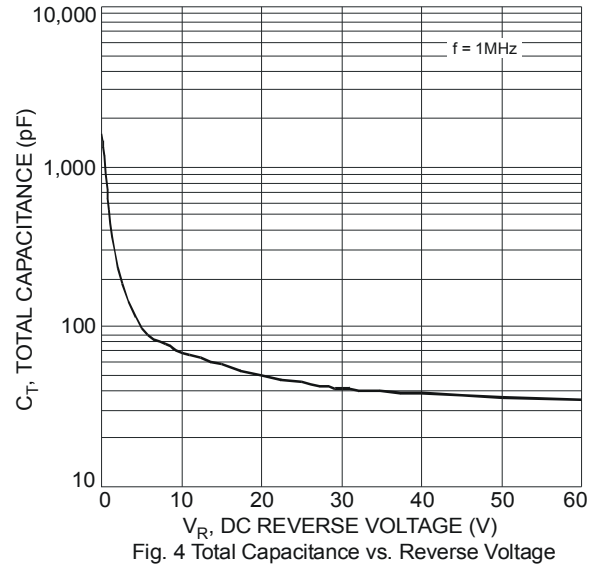
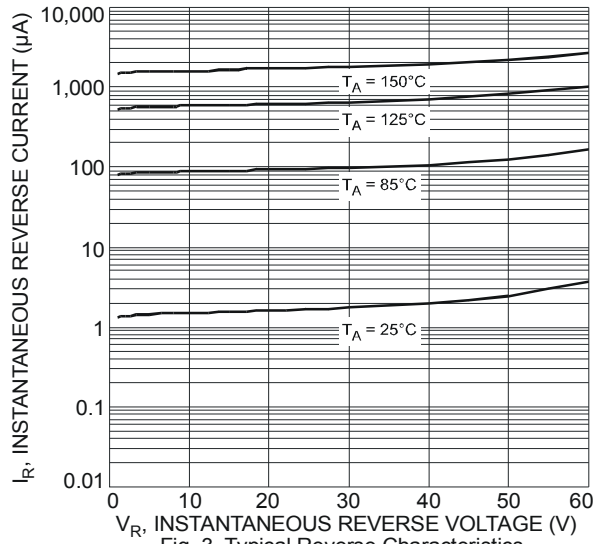
Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Soldering (Note 5)	R _{θJS}	5	°C/W
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	175	°C/W
Operating and Storage Temperature Range (Note 7)	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

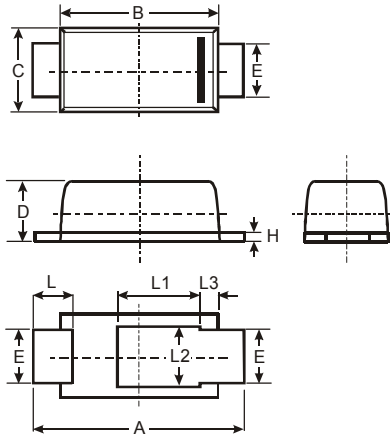
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	-	-	0.650	V	I _F = 3.0A, T _J = +25°C
Leakage Current (Note 7)	I _R	-	-	100	μA	V _R = 60V, T _J = +25°C

Notes: 5. Theoretical R_{θJS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.
 6. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
 7. Short duration pulse test used to minimize self-heating effect.



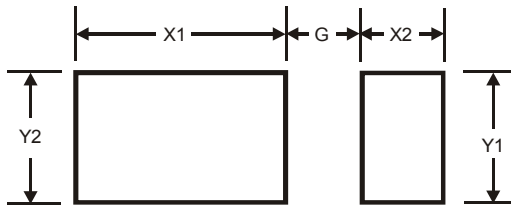


Package Outline Dimensions



POWERDI123			
Dim	Min	Max	Typ
A	3.50	3.90	3.70
B	2.60	3.00	2.80
C	1.63	1.93	1.78
D	0.93	1.00	0.98
E	0.85	1.25	1.00
H	0.15	0.25	0.20
L	0.40	0.50	0.45
L1	-	-	1.35
L2	-	-	1.10
L3	-	-	0.20
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4

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